

Docket No.: 057810-0085

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of

Masayuki HATA, et al.

Application No.: 10/766,031

Filed: January 29, 2004

For: SEMICONDUCTOR DEVICE AND METHOD OF FABRICATING THE SAME



Customer Number: 20277

Confirmation Number: 1109

Group Art Unit: 2815

Examiner: N. Drew Richards

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Mail Stop IDS  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the documents listed on the attached form PTO-1449. It is respectfully requested that the documents be expressly considered during the prosecution of this application, and that the documents be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

This Information Disclosure Statement is being filed within three months of the U.S. filing date OR before the mailing date of a first Office Action on the merits. No certification or fee is required.

Further to applicants' Information Disclosure Statement and PTO-1449 with 13 references, filed April 19, 2007. Applicants note that errors in the machine generated English translation were found in following two references, JP Publication No. 10-093186 and JP Publication No. 2002-033512. The electronic English translation of these documents incorrectly

identifies the terms “p type” and “n type” with the terms “p mold” and “n mold”. The correct translated terminology is “p type” and “n type”. Applicants list the JP Publications and paragraph numbers wherein the incorrect terminology is found.

**JP Publication No. 2002-033512, Published 1/31/2002**

The term “p mold” and “n mold” should be replaced with “p type” and “n type”.

Paragraph [0009], lines 2, 3 and 7;

Paragraph [0011], line 6;

Paragraph [0012], lines 1, 2, 3, 4 and 6;

Paragraph [0013], lines 3 and 6;

Paragraph [0014], lines 2, 5 and 6;

Paragraph [0019], lines 6, 7 and 10;

Paragraph [0021], lines 2, 7 and 9;

Paragraph [0022], lines 4, 6, 7 and 10;

Paragraph [0023], line 3;

Paragraph [0025], lines 2 and 3;

Paragraph [0035], line 4;

Paragraph [0043], line 1;

Paragraph [0046], lines 4, 10 and 11;

Paragraph [0049], line 1.

**JP Publication No. 10-093186, Published 4/10/1998**

Paragraph [0002], lines 7, 8, 9 and 11;

Paragraph [0004], line 3;

Paragraph [0010], lines 4, 5, 8 and 9;

Paragraph [0011], lines 1 and 2;

Paragraph [0016], lines 3, 5 and 12;

Paragraph [0017], lines 6 and 7;

Paragraph [0018], lines 3 and 4;

Paragraph [0020], lines 1, 2, 3, 4, 7 and 8;

Paragraph [0023], lines 2, 3, 4, 5, 8, 9, 10, 11 and 12;

Paragraph [0026], lines 1 and 6;

Paragraph [0027], lines 1 and 3;

Paragraph [0028], lines 1 and 2;

Paragraph [0029], line 1;

Paragraph [0031], lines 1, 2 and 7;

Paragraph [0032], lines 1, 2 and 3;

Paragraph [0033], lines 1 and 3;

Paragraph [0034], lines 1 and 2;

Paragraph [0035], lines 3, 4 and 6;

Paragraph [0036], lines 1, 2, 4 and 5;

Paragraph [0037], lines 1, 2, 3 and 4.

10/766,031

Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account 500417 and please credit any excess fees to such deposit account.

Respectfully submitted,

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